

а 🔨 Міскоснір сотралу

Helping Customers Innovate, Improve & Grow

Table 1. Electrical Performance						
Parameter	Symbol	Min.	Тур	Max	Units	
Nominal Frequency	F _{NOM}	8.000		150.000	MHz	
Mode						
Operating Temperature Range	T _{op}	0/70, -10/70, -20/70, -40/85 °C				
Stability Over T _{OP} ¹	F _{STAB}	±10		±100	ppm	
Frequency Tolerance ²	F _{TOL}		±10		ppm	
Load Capacitance	CL	6		32	pF	
Shunt Capacitance	C			5	pF	
Drive Level			10	100	uW	
Aging / 1st year (at 25 °C)	F _{AGE}			±5	ppm	
Insulation Resistance		500			MOhm	
Storage Temperature	Τ _{sto}	-40		90	°C	
	Equivalent Se	eries Resistance				
Crystal Frequency 8.000MHz-12.000MHz 12.001MHz-16.000MHz 16.001MHz-20.000MHz 20.001MHz-24.000MHz 24.001MHz-54.000MHz 40.000MHz-150.000MHz, 3rd Overtone	ESR			80 60 50 40 30 80	Ohm	

Notes:

1. Referenced to the Frequency at 25 °C.

2. Frequency measured at 25 °C \pm 3 °C.

Product is compliant to RoHS directive and fully compatible with lead free assembly.

4 - R0.20

Package Drawing



Tape & Reel

Table	Table 7. Tape and Reel Dimensions (mm)																	
Таре												Reel						
Α	В	С	D	E	F	G	Н	J	К	L	М	Α	В	С	D	Е	W	Т
5.25	3.45	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.5	0.3	1.1	178	180	21.0	13.0	2.0	12.4	2.0



Reliability & IR Compliance

Solderprofile:



Table 2: Reflow Profile							
Parameter	Symbol	Value					
PreHeat Time Ts-min Ts-max	t _s	60 sec Min, 260 sec Max 150℃ 200℃					
Ramp Up	R _{up}	3 °C/sec Max					
Time Above 217 °C	t	60 sec Min, 150 sec Max					
Time To Peak Temperature	T _{AMB-P}	480 sec Max					
Time at 260 °C	t _e	30 sec Max					
Ramp Down	R _{DN}	6 °C/sec Max					

Pads are Au over Ni and compatible with either SnPb or Pb free attachment. MSL: 1



other specifications may be available aportrequ

10ppm stability not available for -40 to $85^\circ C$

* Add **_SNPBDIP** for tin lead solder dip Example: VXM2-1KE-18-10M000000_SNPBDIP

Revision History

Revision Date	Approved	Description
August 29, 2016	RC	Initial datasheet for factory approval and release to customer.
August 10, 2018	FB	Update loo and contact information, add "SNPBDIP" ordering option



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